

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Inventor Rickie C. Lake et al
Assignee Micron Technology, Inc.
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Priority Examiner D. Hamlin
Attorney's Docket No. MI40-327
Title: An Epoxy, Epoxy System, and Method of Forming a Conductive
Adhesive Connection

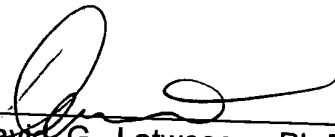
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